

High Temperature Silicon Carbide Power Schottky Diode

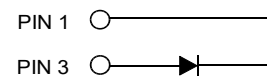
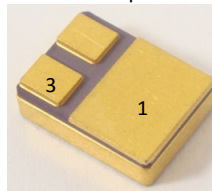
V_{RRM}	=	650 V
I_F ($T_C=25^\circ\text{C}$)	=	4 A
Q_C	=	7 nC

Features

- 650 V Schottky rectifier
- 210 °C maximum operating temperature
- Zero reverse recovery charge
- Superior surge current capability
- Positive temperature coefficient of V_F
- Temperature independent switching behavior
- Lowest figure of merit Q_C/I_F
- Available screened to Mil-PRF-19500

Package

- RoHS Compliant



SMD0.5 / TO – 276 (Hermetic Package)

Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

Applications

- Down Hole Oil Drilling
- Geothermal Instrumentation
- Solenoid Actuators
- General Purpose High-Temperature Switching
- Amplifiers
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)

Maximum Ratings at $T_J = 210^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V_{RRM}		650	V
Continuous forward current	I_F	$T_C = 25^\circ\text{C}$	4	A
Continuous forward current	I_F	$T_C \leq 190^\circ\text{C}$	1	A
RMS forward current	$I_{F(RMS)}$	$T_C \leq 190^\circ\text{C}$	2	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}$, $t_p = 10\text{ ms}$	10	A
Non-repetitive peak forward current	$I_{F,max}$	$T_C = 25^\circ\text{C}$, $t_p = 10\text{ }\mu\text{s}$	65	A
I^2t value	$\int I^2 dt$	$T_C = 25^\circ\text{C}$, $t_p = 10\text{ ms}$	0.5	A^2S
Power dissipation	P_{tot}	$T_C = 25^\circ\text{C}$	64	W
Operating and storage temperature	T_J, T_{stg}		-55 to 210	$^\circ\text{C}$

Electrical Characteristics at $T_J = 210^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	V_F	$I_F = 1\text{ A}$, $T_J = 25^\circ\text{C}$ $I_F = 1\text{ A}$, $T_J = 210^\circ\text{C}$		1.6 2.6		V
Reverse current	I_R	$V_R = 650\text{ V}$, $T_J = 25^\circ\text{C}$ $V_R = 650\text{ V}$, $T_J = 210^\circ\text{C}$		1 5	5 50	μA
Total capacitive charge	Q_C	$I_F \leq I_{F,MAX}$ $dI_F/dt = 200\text{ A}/\mu\text{s}$ $T_J = 210^\circ\text{C}$		7		nC
Switching time	t_s	$V_R = 400\text{ V}$ $V_R = 400\text{ V}$		< 17		ns
Total capacitance	C	$V_R = 1\text{ V}$, $f = 1\text{ MHz}$, $T_J = 25^\circ\text{C}$ $V_R = 400\text{ V}$, $f = 1\text{ MHz}$, $T_J = 25^\circ\text{C}$ $V_R = 650\text{ V}$, $f = 1\text{ MHz}$, $T_J = 25^\circ\text{C}$		76 12 12		pF

Thermal Characteristics

Thermal resistance, junction - case	R_{thJC}	3.55	$^\circ\text{C}/\text{W}$
-------------------------------------	------------	------	---------------------------

Mechanical Properties

Mounting torque	M	0.6	Nm
-----------------	---	-----	----

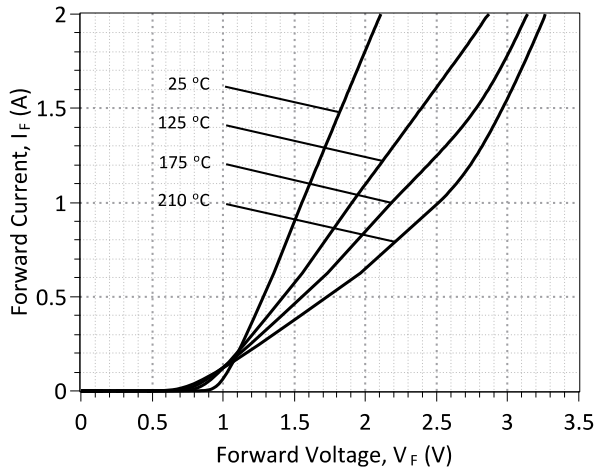


Figure 1: Typical Forward Characteristics

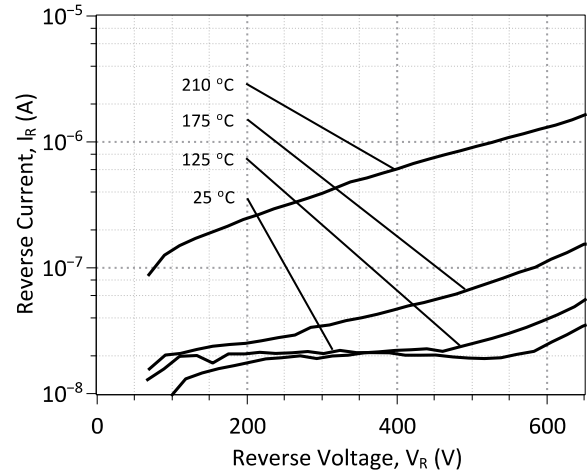


Figure 2: Typical Reverse Characteristics

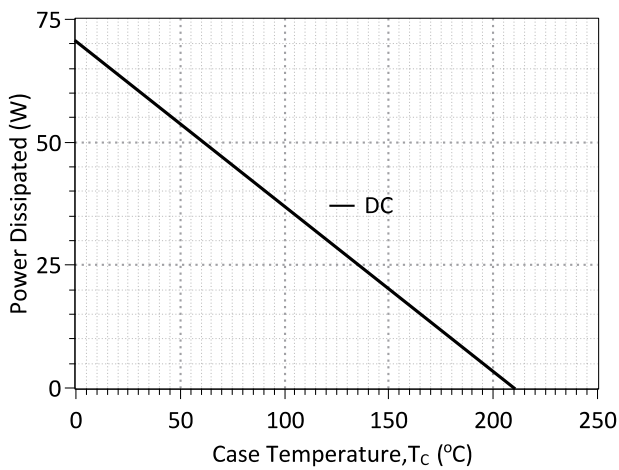
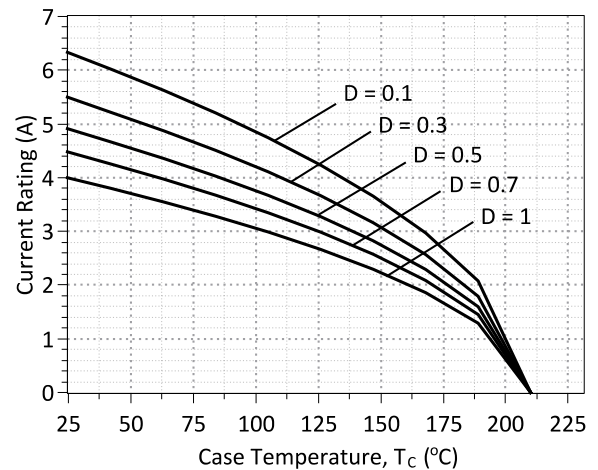


Figure 3: Power Derating Curve



**Figure 4: Current Derating Curves ($D = t_p/T$, $t_p = 400 \mu s$)
(Considering worst case Z_{th} conditions)**

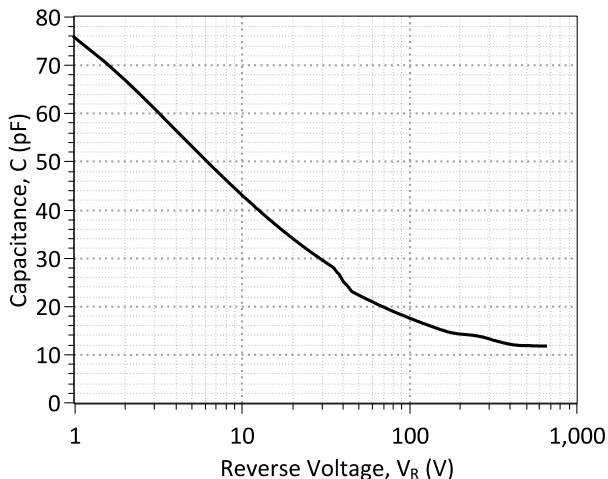


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

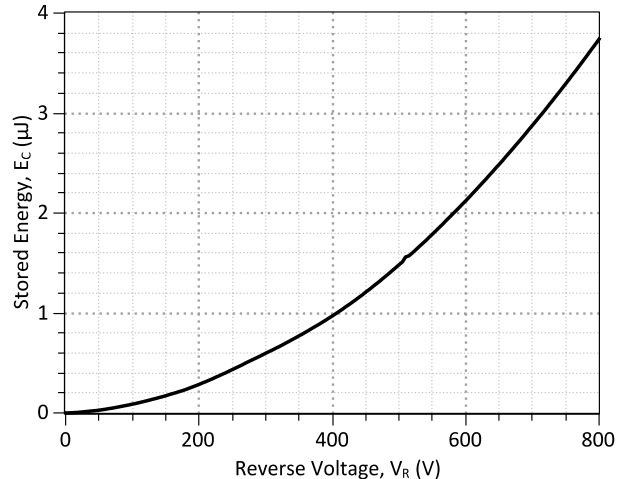


Figure 6: Typical Capacitive Energy vs Reverse Voltage Characteristics

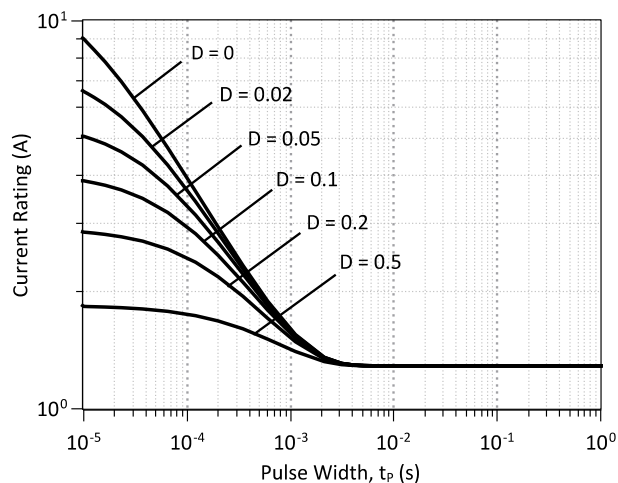


Figure 7: Current vs Pulse Duration Curves at $T_c = 190\text{ }^\circ\text{C}$

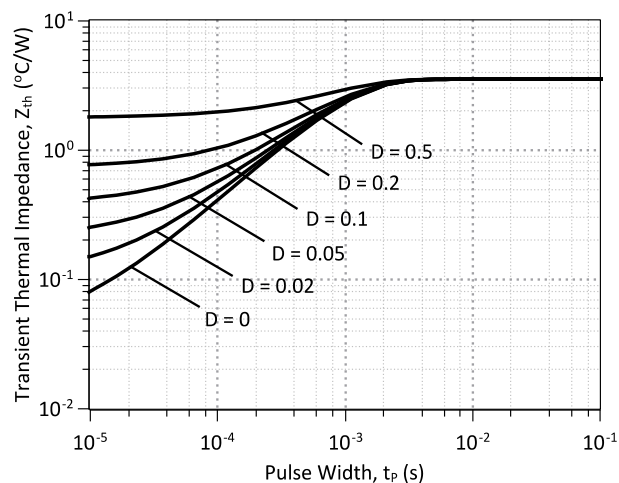
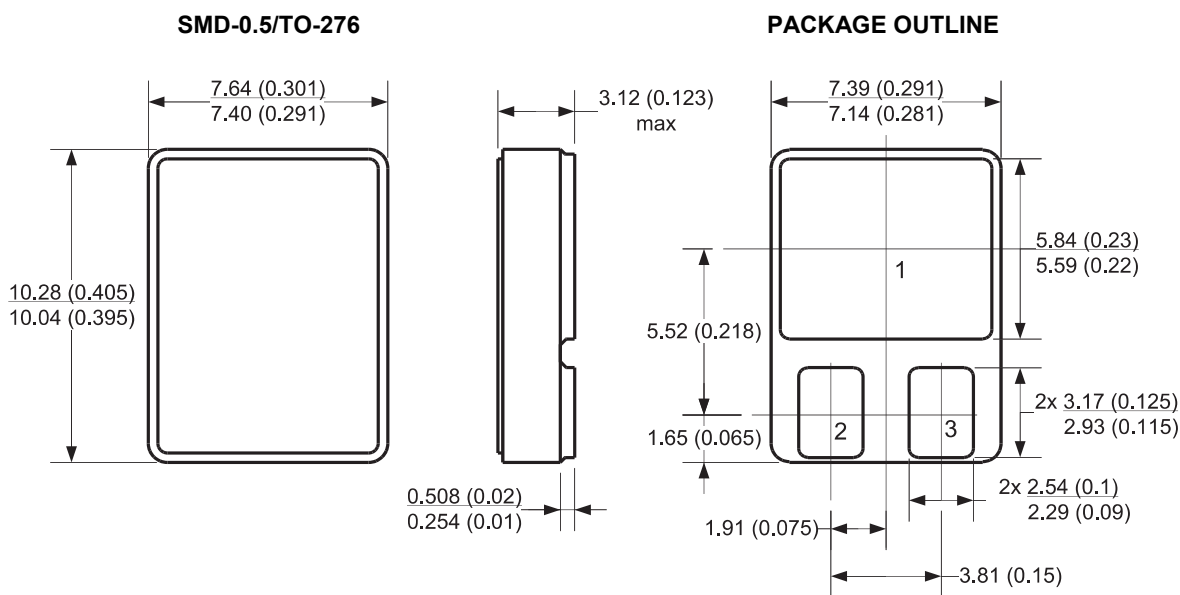


Figure 8: Transient Thermal Impedance

Package Dimensions:



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

Revision History

Date	Revision	Comments	Supersedes
2014/08/26	1	Updated Electrical Characteristics	
2012/04/24	0	Initial release	

Published by

GeneSiC Semiconductor, Inc.
43670 Trade Center Place Suite 155
Dulles, VA 20166

GeneSiC Semiconductor, Inc. reserves right to make changes to the product specifications and data in this document without notice.

GeneSiC disclaims all and any warranty and liability arising out of use or application of any product. No license, express or implied to any intellectual property rights is granted by this document.

Unless otherwise expressly indicated, GeneSiC products are not designed, tested or authorized for use in life-saving, medical, aircraft navigation, communication, air traffic control and weapons systems, nor in applications where their failure may result in death, personal injury and/or property damage.

SPICE Model Parameters

This is a secure document. Copy this code from the SPICE model PDF file on our website into a SPICE software program for simulation of the 1N8031-GA.

```
*      MODEL OF GeneSiC Semiconductor Inc.
*
*      $Revision:   1.0           $
*      $Date:      05-SEP-2013    $
*
*      GeneSiC Semiconductor Inc.
*      43670 Trade Center Place Ste. 155
*      Dulles, VA 20166
*
*      COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
*      ALL RIGHTS RESERVED
*
*      These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
*      OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
*      TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
*      PARTICULAR PURPOSE."
*      Models accurate up to 2 times rated drain current.
*
*      Start of 1N8031-GA SPICE Model
*
.SUBCKT 1N8031 ANODE KATHODE
D1 ANODE KATHODE 1N8031_25C; Call the Schottky Diode Model
D2 ANODE KATHODE 1N8031_PIN; Call the PiN Diode Model
.MODEL 1N8031_25C D
+ IS      3.57E-18          RS      0.49751
+ TRS1    0.0057           TRS2    2.40E-05
+ N       1                IKF      322
+ EG      1.2              XTI      3
+ CJO     9.12E-11         VJ       0.371817384
+ M       1.527759838      FC       0.5
+ TT      1.00E-10         BV       650
+ IBV     1.00E-03         VPK      650
+ IAVE    1                TYPE     SiC_Schottky
+ MFG     GeneSiC_Semiconductor
.MODEL 1N8031_PIN D
+ IS      5.73E-11         RS      0.72994
+ N       5                IKF      800
+ EG      3.23             XTI      -14
+ FC      0.5              TT       0
+ BV      650              IBV      1.00E-03
+ VPK     650              IAVE     1
+ TYPE    SiC_PiN
.ENDS
*
*      End of 1N8031-GA SPICE Model
```

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[GeneSiC Semiconductor:](#)

[1N8031-GA](#)